

Complementary MOSFET

ELM35601KA-S

■ General Description

ELM35601KA-S uses advanced trench technology to provide excellent Rds(on) and low gate charge.

■ Features

N-channel	P-channel
• Vds=40V	Vds=-40V
• Id=7A	Id=-5.5A
• Rds(on) < 28mΩ (Vgs=10V)	Rds(on) < 48mΩ (Vgs=-10V)
• Rds(on) < 49mΩ (Vgs=5V)	Rds(on) < 85mΩ (Vgs=-5V)

■ Maximum Absolute Ratings

Parameter	Symbol	N-ch (Max.)	P-ch (Max.)	Unit	Note
Drain-source voltage	Vds	40	-40	V	
Gate-source voltage	Vgs	±20	±20	V	
Continuous drain current	Ta=25°C	7.0	-5.5	A	
	Ta=70°C	6.0	-4.5		
Pulsed drain current	Idm	50	-50	A	1
Power dissipation	Ta=25°C	3.0	3.0	W	
	Ta=70°C	2.1	2.1		
Junction and storage temperature range	Tj,Tstg	-55 to 150	-55 to 150	°C	

■ Thermal Characteristics

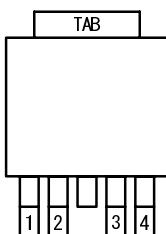
Parameter	Symbol	Device	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	Rθja	N-ch		42	°C/W	
Maximum junction-to-case	Rθjc	N-ch		6	°C/W	
Maximum junction-to-ambient	Rθja	P-ch		42	°C/W	
Maximum junction-to-case	Rθjc	P-ch		6	°C/W	

1. Pulse width limited by maximum junction temperature.

2. Duty cycle ≤ 1%.

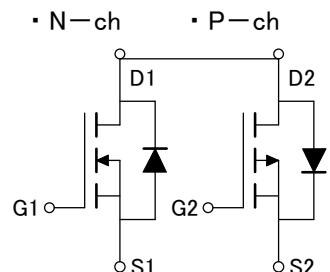
■ Pin Configuration

TO-252-4 (TOP VIEW)



Pin No.	Pin name
1	SOURCE1
2	GATE1
3	SOURCE2
4	GATE2
TAB	DRAIN1/DRAIN2

■ Circuit



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■ Electrical Characteristics (N-ch)

T_a=25°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=250μA, Vgs=0V	40			V	
Zero gate voltage drain current	Idss	Vds=32V, Vgs=0V			1	μA	
		Vds=30V, Vgs=0V, Tj=55°C			10		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250μA	1.2	2.0	3.0	V	
On state drain current	Id(on)	Vgs=10V, Vds=5V	50			A	1
Static drain-source on-resistance	Rds(on)	Vgs=10V, Id=7A		24	28	mΩ	1
		Vgs=5V, Id=6A		38	49		
Forward transconductance	Gfs	Vds=10V, Id=7A		19		S	1
Diode forward voltage	Vsd	If=7A, Vgs=0V			1.2	V	1
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=10V, f=1MHz		530	662	pF	
Output capacitance	Coss			118	165	pF	
Reverse transfer capacitance	Crss			44	66	pF	
SWITCHING PARAMETERS							
Total gate charge	Qg	Vgs=10V, Vds=20V, Id=7A		12.8		nC	2
Gate-source charge	Qgs			2.0		nC	2
Gate-drain charge	Qgd			1.7		nC	2
Turn-on delay time	td(on)	Vgs=10V, Vds=20V, Id ≈ 1A Rgen=6Ω		1.8	3.5	ns	2
Turn-on rise time	tr			6.0	12.0	ns	2
Turn-off delay time	td(off)			8.2	15.1	ns	2
Turn-off fall time	tf			3.0	5.9	ns	2
Body diode reverse recovery time	trr	If=8A, dl/dt=100A/μs		42		ns	
Body diode reverse recovery charge	Qrr			30		nC	

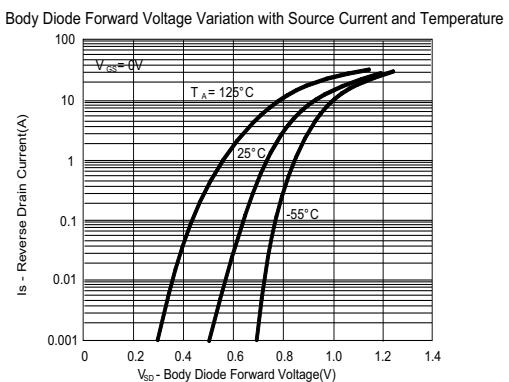
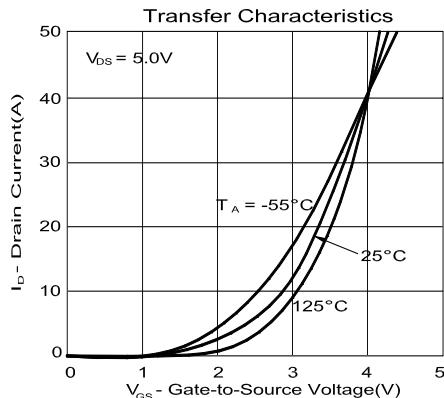
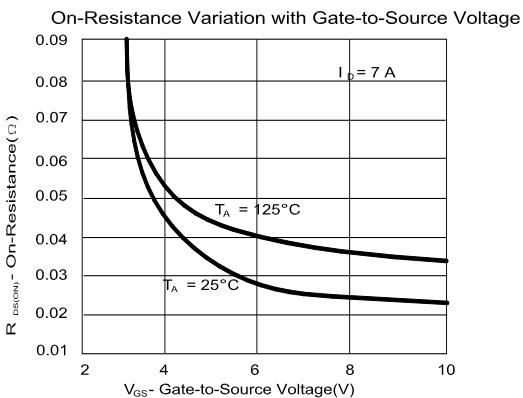
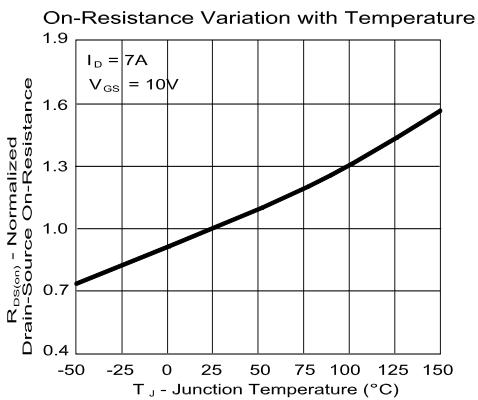
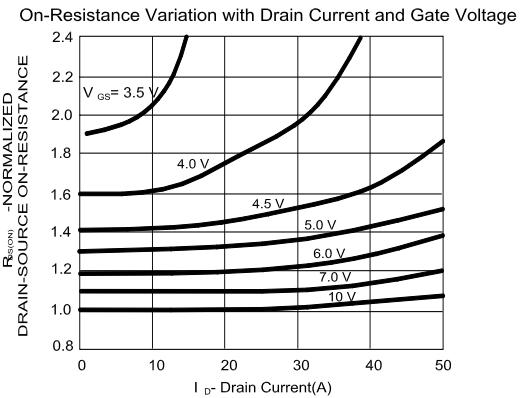
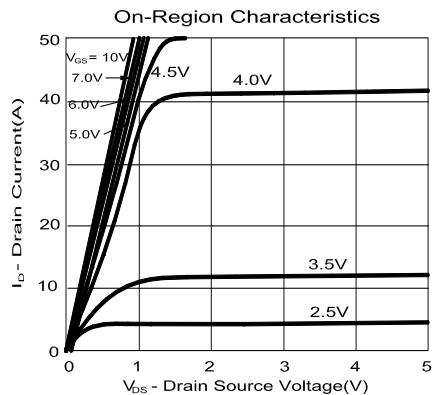
NOTE :

1. Pulse test : Pulse width ≤ 300μsec, duty cycle ≤ 2%.
2. Independent of operating temperature.
3. Pulse width limited by maximum junction temperature.

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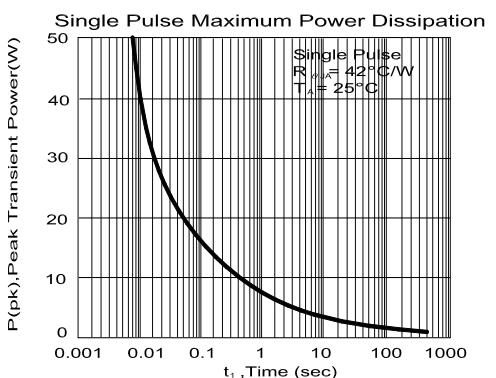
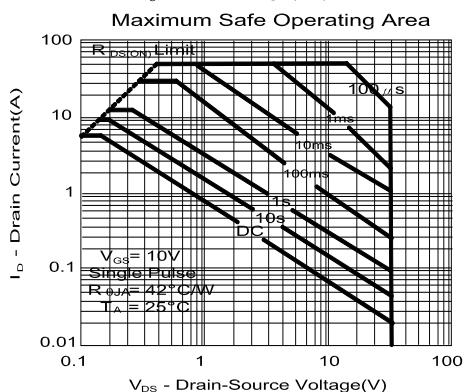
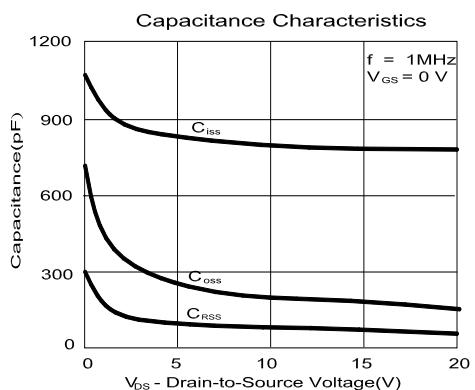
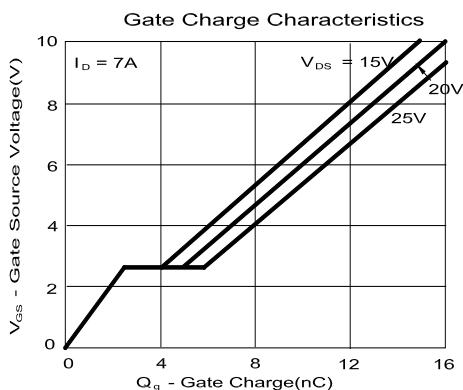
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■ Typical Electrical and Thermal Characteristics (N-ch)



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■ Electrical Characteristics (P-ch)

T_a=25°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=-250 μA, Vgs=0V	-40			V	
Zero gate voltage drain current	Idss	Vds=-32V, Vgs=0V			-1	μ A	
		Vds=-30V, Vgs=0V, Tj=55°C			-10		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250 μA	-1.2	-2.0	-3.0	V	
On state drain current	Id(on)	Vgs=-10V, Vds=-5V	-50			A	1
Static drain-source on-resistance	Rds(on)	Vgs=-10V, Id=-5.5A		37	48	m Ω	1
		Vgs=-5V, Id=-4.5A		56	85		
Forward transconductance	Gfs	Vds=-10V, Id=-5.5A		11		S	1
Diode forward voltage	Vsd	If=-5.5A, Vgs=0V			-1.2	V	1
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=-10V, f=1MHz		690	863	pF	
Output capacitance	Coss			310	430	pF	
Reverse transfer capacitance	Crss			75	113	pF	
SWITCHING PARAMETERS							
Total gate charge	Qg	Vgs=-10V, Vds=-20V Id=-5.5A		14.0		nC	2
Gate-source charge	Qgs			2.2		nC	2
Gate-drain charge	Qgd			1.9		nC	2
Turn-on delay time	td(on)	Vgs=-10V, Vds=-20V Id ≈ -1A, Rgen=6 Ω		6.7	13.4	ns	2
Turn-on rise time	tr			9.7	19.4	ns	2
Turn-off delay time	td(off)			19.8	35.6	ns	2
Turn-off fall time	tf			12.3	22.2	ns	2
Body diode reverse recovery time	trr	If=-7A, dl/dt=100A/μs		55		ns	
Body diode reverse recovery charge	Qrr			52		nC	

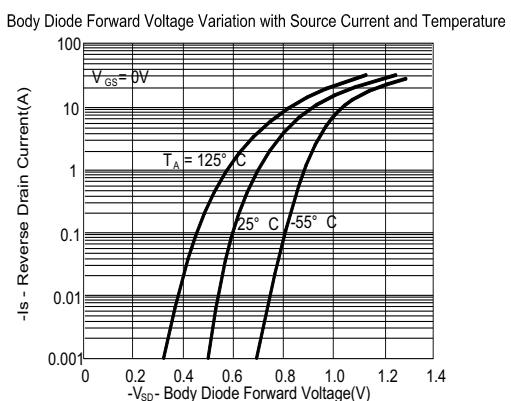
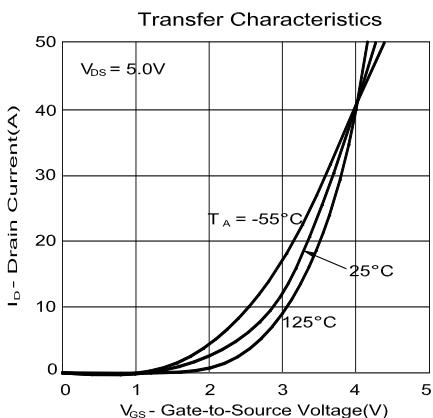
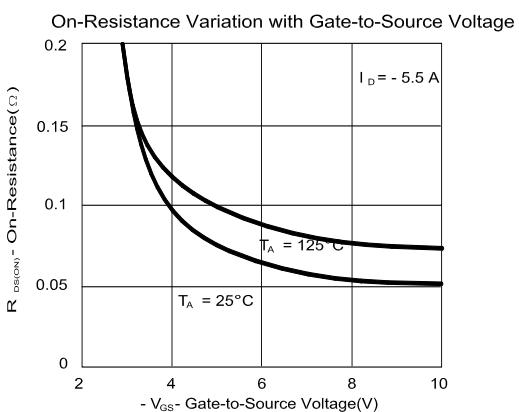
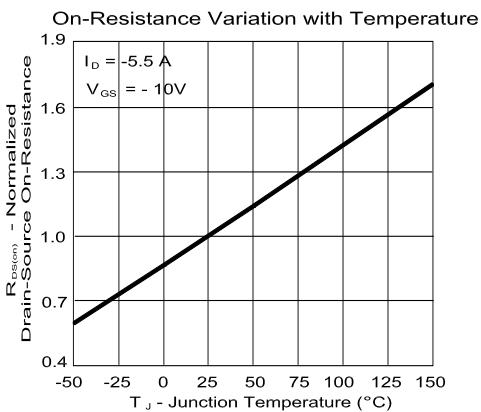
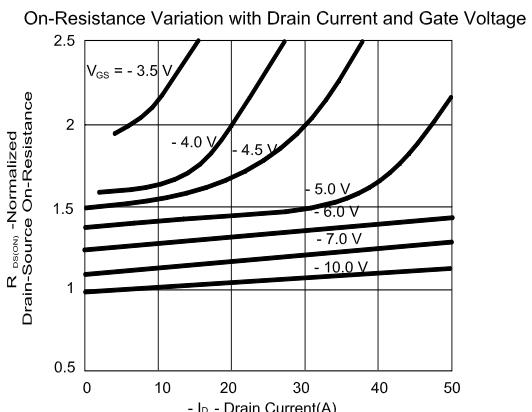
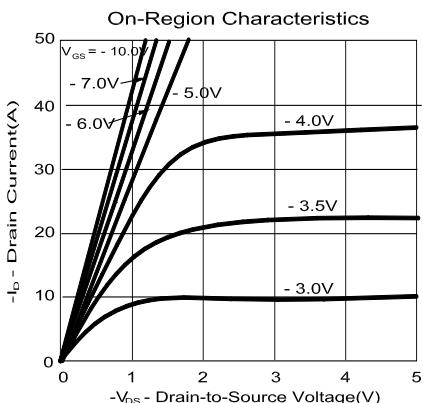
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